

# **ULTRA LOW CAPACITANCE TVS ARRAY**

#### **APPLICATIONS**

- ✓ Ethernet 10/100/1000 Base T
- ✔ Cellular Phones
- ✓ Audio/Video Inputs
- ✔ Personal Digital Assistant (PDA)

# IEC COMPATIBILITY (EN61000-4)

- ✓ 61000-4-2 (ESD): Air 15kV, Contact 8kV
- ✓ 61000-4-4 (EFT): 40A 5/50ns
- ✓ 61000-4-5 (Surge): 24A, 8/20µs Level 2(Line-Ground) & Level 3(Line-Line)

### **FEATURES**

- ✓ 600 Watts Peak Pulse Power per Line (tp = 8/20µs)
- ✔ Provides Protection For Two Line Pairs
- ✓ ESD Protection > 40 kilovolts
- **✓ LOW LEAKAGE CURRENT < 1.0µA**
- **✓** ULTRA LOW CAPACITANCE: 3pF Typical
- ✔ RoHS Complaint in Lead-Free Versions

### **MECHANICAL CHARACTERISTICS**

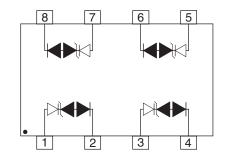
- ✓ Molded JEDEC SO-8
- ✓ Weight 70 milligrams (Approximate)
- ✔ Available in Tin-Lead or Lead-Free Pure-Tin Plating(Annealed)
- ✓ Solder Reflow Temperature:

Tin-Lead - Sn/Pb, 85/15: 240-245°C

Pure-Tin - Sn, 100: 260-270°C

- ✓ Flammability Rating UL 94V-0
- ✓ 12mm Tape and Reel Per EIA Standard 481
- ✓ Device Marking: Marking Code, Logo, Date Code & Pin One Defined By DOT on Package

#### **PINCONFIGURATION**





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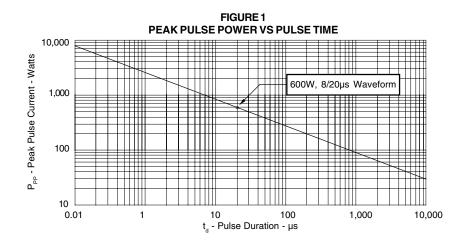
# **DEVICE CHARACTERISTICS**

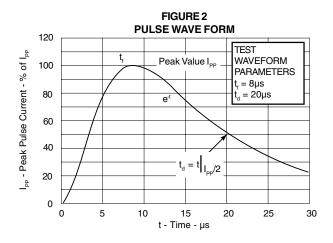
MAXIMUM RATINGS @ 25°C Unless Otherwise Specified							
PARAMETER	SYMBOL	VALUE	UNITS				
Peak Pulse Power ( $t_p = 8/20\mu s$ ) - See Figure 1	P <sub>PP</sub>	600	Watts				
Peak Pulse Current (t <sub>p</sub> = 8/20µs)	l <sub>pp</sub>	30	Amps				
Lead Soldering Temperature	I <sub>FRM</sub>	260°C (10s)	°C				
Operating Temperature	T <sub>J</sub>	-55°C to 150°C	°C				
Storage Temperature	T <sub>STG</sub>	-55°C to 150°C	°C				

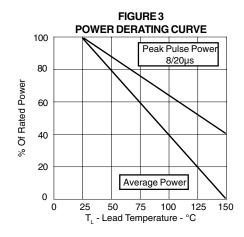
ELECT	ELECTRICAL CHARACTERISTICS PER LINE @ 25°C Unless Otherwise Specified									
PART NUMBER	DEVICE MARKING CODE	RATED STAND-OFF VOLTAGE (See Note 1)	MINIMUM BREAKDOWN VOLTAGE (See Note 1)	MINIMUM SNAPBACK VOLTAGE (See Note 1)	MAXIMUM CLAMPING VOLTAGE (See Note 1) (See Fig. 2)	MAXIMUM LEAKAGE CURRENT (See Note 1)	TYPICAL CAPACITANCE (See Note 1)			
		V <sub>wм</sub> VOLTS	@ 1mA V <sub>(BR)</sub> VOLTS	$@I_{SB} = 50 \text{mA}$ $V_{SB}$ VOLTS	@I <sub>P</sub> =2A V <sub>C</sub> VOLTS	@I <sub>P</sub> =5A V <sub>C</sub> VOLTS	@I <sub>P</sub> =24A V <sub>C</sub> VOLTS	@I <sub>P</sub> =30A V <sub>C</sub> VOLTS	@V <sub>wм</sub> Ι <sub>D</sub> μΑ	@0V, 1MHz C pF
SLVU2.8-4	SL4	2.8	3.0	2.8	5.5	8.5	15	21	1.0	3

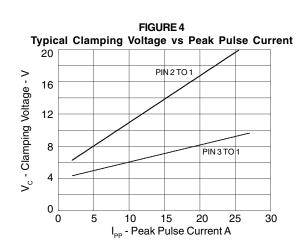
Note 1: Device measured between pin 1 to 2, pin 3 to 4, pin 5 to 6 and pin 7 to 8.

# **GRAPHS**









### APPLICATION NOTE

Electronic equipment is susceptible to damage caused by Electrostatic Discharge (ESD), Electrical Fast Transients (EFT), and tertiary lightning effects. Knowing that equipment can be damaged, the SLVU2.8-4 was designed to provide the level of protection required to safe guard sensitive equipment. This product can be used in different configurations to provide a level of protection to meet unidirectional line requirements as well as bidirectional requirements either in a common-mode or differential-mode configuration.

#### UNIDIRECTIONAL COMMON-MODE CONFIGURATION (Figure 1)

The SLVU2.8-4 provides up to four lines of protection in a common-mode configuration as depicted in figure 1.

Circuit connectivity is as follows:

- ✓ Line 1 is connected to Pin 1
- ✓ Line 2 is connected to Pin 7
- ✓ Line 3 is connected to Pin 3
- ✓ Line 4 is connected to Pin 5
- ✔ Pins 2, 4, 7 and 8 are connected to ground

#### **BIDIRECTIONAL COMMON-MODE CONFIGURATION (Figure 2)**

The SLVU2.8-4 provides up to two lines of protection in a common-mode configuration as depicted in figure 1.

Circuit connectivity is as follows:

- ✓ Line 1 is connected to Pins 1 & 8
- ✓ Line 2 is connected to Pins 4 & 5
- Pins 2, 3, 6, and 7 are connected to ground

#### **BIDIRECTIONAL DIFFERENTIAL-MODE CONFIGURATION (Figure 3)**

The SLVU2.8-4 provides up to two-line pairs of protection in a differential-mode configuration as depicted in figure 1.

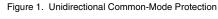
Circuit connectivity is as follows:

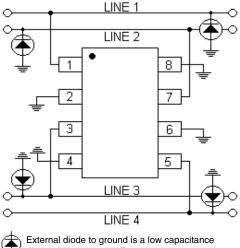
- Line Pair 1 is connected to Pins 1 & 2
- ✓ Line Pair 1 is connected to Pins 7 & 8
- ✓ Line Pair 2 is connected to Pins 3 & 4
- ✓ Line Pair 2 is connected to Pins 5 & 6

### **CIRCUIT BOARD LAYOUT RECOMMENDATIONS**

Circuit board layout is critical for Electromagnetic Compatibility (EMC) protection. The following guidelines are recommended:

- The protection device should be placed near the input terminals or connectors, the device will divert the transient current immediately before it can be coupled into the nearby traces.
- The path length between the TVS device and the protected line should be minimized.
- All conductive loops including power and ground loops should be minimized.
- The transient current return path to ground should be kept as short as possible to reduce parasitic inductance.
- Ground planes should be used whenever possible. For multilayer PCBs, use ground vias.





External diode to ground is a low capacitance diode of less than 10pF

Figure 2. Bidirectional Common-Mode Protection

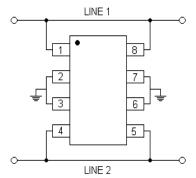
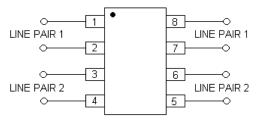
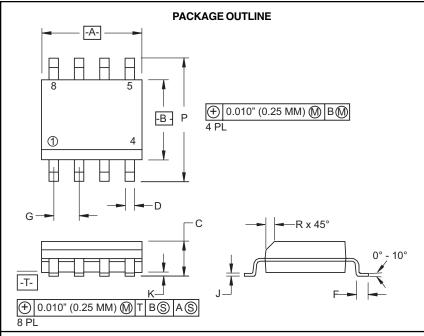
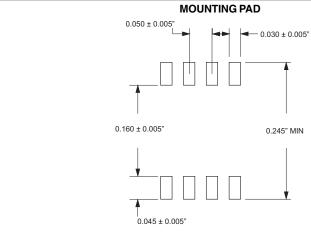


Figure 3. Bidirectional Differential-Mode Protection



# PACKAGE OUTLINE & DIMENSIONS





#### **SO-8**



#### PACKAGE DIMENSIONS

	MILLIME	ETERS	INCHES		
DIM	MIN	MAX	MIN	MAX	
Α	4.80	5.00	0.189	0.196	
В	3.80	4.00	0.150	0.157	
С	1.35	1.75	0.054	0.068	
D	0.35	0.49	0.014	0.019	
F	0.40	1.250	0.016	0.049	
G	1.27 BSC	1.27 BSC	0.05 BSC	0.05 BSC	
J	0.18	0.25	0.007	0.009	
K	0.10	0.25	0.004	0.008	
Р	5.80	6.20	0.229	0.244	
R	0.25	0.50	0.010	0.019	

#### **NOTES**

- 1. T = Seating Plane and Datum Surface.
- 2. Dimensions "A" and "B" are Datum.
- 3. Dimensions "A" and "B" do not include mold protrusion.
- 4. Maximum mold protrusion is 0.015" (0.380 mm) per side.
- 5. Dimensioning and tolerances per ANSI Y14.5M, 1982.
- 6. Dimensions are exclusive of mold flash and metal burrs.

#### TAPE & REEL/BULK ORDERING NOMENCLATURE

- 1. Surface mount product is taped and reeled in accordance with EIA-481.
- 2. Suffix-T7 = 7 Inch Reel 1,000 pieces per 12mm tape, i.e., SLVU2.8-4-T7.
- 3. Suffix-T13 = 13 Inch Reel 2,500 pieces per 12mm tape, i.e., SLVU2.8-4-T13.
- 4. Suffix LF = Lead-Free, Pure Tin Plating,
  - i.e., SLVU2.8-4-LF-T7.
- 5. No Suffix = Product Shipped in Tubes of 98 pcs per Tube.

Outline & Dimensions: Rev 1 - 11/01, 06009

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